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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/751,212 12/30/2003		12/30/2003	Byoung Young Kang	PIA31223/DBE/US	1179	
36872	7590	12/20/2005		EXAMINER		
		S OF ANDREW I	HA, NATHAN W			
7257 N. M. BLDG. D.			ART UNIT	PAPER NUMBER		
FRESNO, CA 93720				2814		
				DATE MAILED: 12/20/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)					
	10/751,212	KANG, BYOUNG YOUNG					
Office Action Summary	Examiner	Art Unit					
	Nathan W. Ha	2814					
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the co	orrespondence address					
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	TE OF THIS COMMUNICATION 6(a). In no event, however, may a reply be tim ill apply and will expire SIX (6) MONTHS from to cause the application to become ABANDONED	I. ely filed the mailing date of this communication. D (35 U.S.C. § 133).					
Status							
Responsive to communication(s) filed on <u>12 October 2005</u> . This action is FINAL. 2b) ☐ This action is non-final. Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposition of Claims							
 4) Claim(s) 1-4 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1-4 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement. 							
Application Papers							
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) access Applicant may not request that any objection to the Replacement drawing sheet(s) including the correction 11) The oath or declaration is objected to by the Examine 11.	epted or b) objected to by the Edrawing(s) be held in abeyance. See on is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).					
Priority under 35 U.S.C. § 119							
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 							
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:						

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.

2. Claims 1-3 are rejected under 35 U.S.C. 102(a) as being anticipated by Soga et al. (2002/0171157, newly cited, hereinafter, Soga.)

In regard to claim 1, in figs. 15 and 16, Soga discloses a method for packaging a semiconductor device, comprising the steps:

forming an Au bump, or metal ball, 80 on a bond pad 84 of a wafer;

dicing the wafer into chips, as shown in the diagram, fig. 15;

attaching the bump of the chip to a substrate to form a flip-chip bond using a thermal pressure process. See paragraph [0116].

In regard to claim 2, the bump is connected to the substrate through an Ag layer and a Cu layer. See also [0116].

In regard to claim 3, Soga further discloses the step of encapsulating the bond using a nonconductive epoxy, or resin, layer 81after step c.

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Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

4. Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over Soga as applied to claims 1-3 above, and further in view of Fukao et al. (US 2003/0011078, newly cited, hereinafter, Fukao.)

In regard to claim 4, Soga's fig. 15 shows a diagram of forming a package, but does not explicitly show the cutting into several packages. It should be noted that the step of singulate wafer into individual chip must be done during a process of forming chips on a wafer since in general a single chip cannot be formed alone. For example, Fukao, in diagram in fig. 28 shows the necessity of the sawing step as finish cutting in order to provide a sufficient way to pack the chip for shipping.

Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention was made to realize the necessity step as taught by Fukao in order to take the advantage as mentioned above.

Response to Arguments

5. Applicant's arguments with respect to claims 1-4 have been considered but are most in view of the new ground(s) of rejection.

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Conclusion

6. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Nathan W. Ha whose telephone number is (571) 272-1707. The examiner can normally be reached on M-TH 8:00-7:00(EST).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Nathan Ha December 12, 2005

> HOAI PHAM PRIMARY EXAMINER